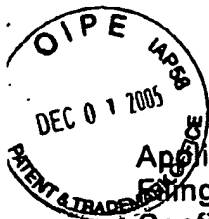


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03/29/2006 JMC MILLA 00000003 230925 10655997

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application Serial No. .... 10/655,997  
Filing Date ..... September 5, 2003  
Confirmation No. .... 7524  
Inventor ..... Jon P. Daley  
Assignee ..... Micron Technology, Inc.  
Group Art Unit ..... 2822  
Examiner ..... Pamela E. Perkins  
Attorney's Docket No. .... MI22-2380  
Customer No. .... 021567  
Title: Methods of Forming Patterned Photoresist Layers Over Semiconductor  
Substrates

**RESPONSE TO AUGUST 8, 2005 FINAL OFFICE ACTION**  
**PRELIMINARY AMENDMENT TO ACCOMPANY RCE FILING**

*Fee  
Only*

To: Mail Stop RCE  
Commissioner for Patents  
P. O. Box 1450  
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601 West First Avenue, Suite 1300  
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Responsive to the Final Office Action dated August 8, 2005, Applicant  
amends and remarks as follows:

**AMENDMENTS**

12/05/2005 DENMANU1 00000109 10655997

01 FC:1201 400.00 OP  
02 FC:1202 200.00 OP

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